

1. DESCRIPTION

The 3232 series devices device consists of two line drivers, two line receivers, and a dual charge-pump circuit with 15-kV ESD protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The devices operate at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate.

2. FEATURES

- RS-232 Bus-Pin ESD Protection
 - ±15 kV Using Human-Body Model (HBM)
 - ±8kV (IEC6 1000-4-2, Contact Discharge)
 - ±15kV (IEC6 1000-4-2, Air Gap Discharge)
- Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards
- Operates With 3-V to 5.5-V VCC Supply
- Operates Up To 250 kbit/s
- Two Drivers and Two Receivers
- Low Supply Current: 300 μA (Typical)
- External Capacitors: 4 × 0.1 μF
- Accepts 5-V Logic Input With 3.3-V Supply

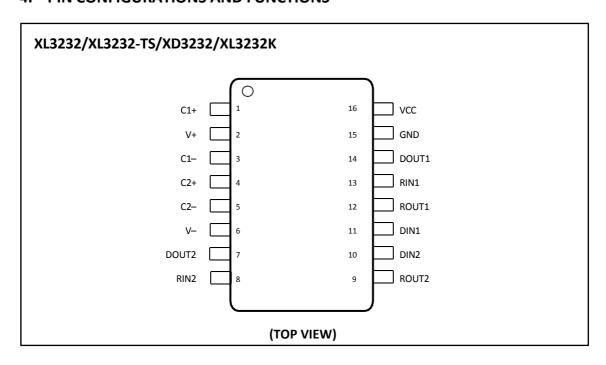
3. Applications

- Industrial PC
- Wired Networks
- Data Centre and Enterprise Networking
- Battery-Powered Systems
- PDAs
- Laptops
- Portable Computers
- Pocket PC
- Handheld Devices

www.xinluda.com 1 / 16 Rev 2.3



4. PIN CONFIGURATIONS AND FUNCTIONS

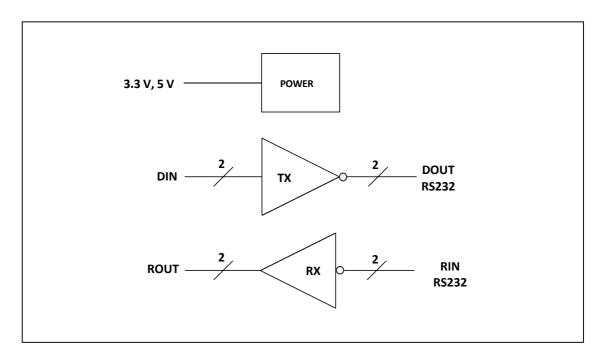


Pin Functions

PIN			
NAME NO.		1/0	DESCRIPTION
C1+	1	_	Positive lead of C1 capacitor
V+	2	0	Positive charge pump output for storage capacitor only
C1 -	3	_	Negative lead of C1 capacitor
C2+	4	_	Positive lead of C2 capacitor
C2 -	5	_	Negative lead of C2 capacitor
V -	6	0	Negative charge pump output for storage capacitor only
DOUT2	7	0	RS232 line data output (to remote RS232 system)
RIN2	8	I	RS232 line data input (from remote RS232 system)
ROUT2	9	0	Logic data output (to UART)
DIN2	10	I	Logic data input (from UART)
DIN1	11	I	Logic data output (from UART)
ROUT1	12	0	Logic data input (to UART)
RIN1	13	I	RS232 line data output (from remote RS232 system)
DOUT1	14	0	RS232 line data input (to remote RS232 system)
GND	15	_	Ground
VCC	16	_	Supply Voltage, Connect to external 3-V to 5.5-V power supply



5. FUNCTIONAL BLOCK DIAGRAM



Block Diagram

www.xinluda.com 3 / 16 Rev 2.3



6. SPECIFICATIONS

6.1. Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
VCC	Supply voltage ⁽²⁾		- 0.3	6	V
V+	Positive output supply voltage(2)		- 0.3	7	V
V -	Negative output supply voltage ⁽²⁾		- 7	0.3	V
V+ - V -	V+ - V - Supply voltage difference ⁽²⁾			13	V
		Drivers	- 0.3	6	V
Vı	Input voltage	Receivers	- 25	25	V
		Drivers	-13.2	13.2	V
Vo	Output voltage	Receivers	- 0.3	V _{CC} + 0.3	V
T _J Operating virtual junction temperature				125	°C
T _{Stg}	Storage temperature		-45	150	°C

^[1] Operation outside the Absolute Maximum Ratings may cause permanent device damage. Absolute Maximum Ratings do not imply functional operation of the device at these or any other conditions beyond those listed under Recommended Operating Conditions.

If used outside the Recommended Operating Conditions but within the Absolute Maximum Ratings, the device may not be fully functional, and this may affect device reliability, functionality, performance, and shorten the device lifetime

6.2. Thermal Resistance Characteristics

	XL (SOP)	TS (TSSOP)	XD (DIP)	UNIT	
		16 PINS	16 PINS	16 PINS	
R _{e JA}	Junction-to-ambient thermal resistance	85.9	103.1	66.6	°C/W
R θ JCtop	Junction-to-case (top) thermal resistance	43.1	49.2	32.4	°C/W
R _{e JB}	Junction-to-board thermal resistance	44.5	54.8	31.9	°C/W
ψ ,π	Junction-to-top characterization parameter	10.1	12	8.4	°C/W
ψ лв	Junction-to-board characterization parameter	44.1	54.1	31.5	°C/W
R e JCbot	Junction-to-case (bottom) thermal resistance	N/A	N/A	N/A	°C/W

6.3. ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ ESDA/JEDEC JS-001	±2000	
V _(ESD) Electrostatic discharge	RIN, DOUT and DOUT Pins ⁽¹⁾	±15,000		
	Charged-device model (CDM), per JEDEC specification JESD22-C101 All other pins $^{(2)}$	±1500	V	
	Charging Device Model (CDM), JEDEC Specification JESD22-C101, All Pins ⁽²⁾			

^[1] JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

www.xinluda.com 4 / 16 Rev 2.3

^[2] All voltages are with respect to network GND.

^[2] JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.4. Recommended Operating Conditions

See Figure 9-1.

						MAX	UNIT	
Vec	Voc			3	3.3	3.6	v	
\(\curl{C}\)	VCC Supply voltage		V _{CC} = 5V	4.5	5	5.5	v	
VIH	Driver high-level input voltage	DIN	V _{CC} = 3.3V	2			V	
VIH.	Driver night-lever input voltage	DIN	V _{CC} = 5V	2.4			\ \ \ \	
VIL	Driver low-level input voltage	DIN				0.8	٧	
.,	Driver input voltage	Driver input voltage DIN		0		5.5	.,	
Vı	Receiver input voltage RI			- 25		25	V	
T _A	Operating free-air temperature		XL3232、XL3232-TS XD3232	- 40		85	°C	

^[1] Test conditions are C1–C4 = 0.1μ F (VCC = 3.3V ± 0.3 V); C1 = 0.047μ F, C2–C4 = 0.33μ F (VCC = 5V ± 0.5 V)

6.5. Electrical Characteristics - DEVICE(2)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

PARAMETER	TEST CONDITIONS	MIN TYP ⁽²⁾	MAX	UNIT
I _{cc} Supply current	No load, V _{CC} = 3.3 V or 5 V	0.5	10	mA

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = $25 ^{\circ}\text{C}$.

6.6. Electrical Characteristics -DRIVER(2)

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

PARAMETER		TEST CONDI	MIN	TYP ⁽¹⁾	MAX	UNIT	
V _{OH}	High-level output voltage	DOUT at R $_{L}$ = 3 $k\Omega$ to GND,	DIN = GND	5	5.4		٧
V _{OL}	Low-level output voltage	DOUT at $R_L = 3 \text{ k}\Omega$ to GND,	DIN = V _{CC}	- 5	- 5.4		٧
I _{IH}	High-level input current	$V_{I} = V_{CI}$	$V_{I} = V_{CC}$		±0.01	±1	μА
I _{IL}	Low-level input current	V _I at GN	D		±0.01	±1	μА
I _{OS} (2)		V _{CC} = 3.6 V,	$V_0 = 0 V$				
los (=)	Short-circuit output current	V _{CC} = 5.5 V,	$V_0 = 0 V$		±35	±60	mA
r _o	Output resistance	V_{CC} , V+, and V - = 0 V,	$V_0 = \pm 2 V$	300	10M		Ω

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = 25° C.

www.xinluda.com 5 / 16 Rev 2.3

^[2] Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V ± 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V ± 0.5 V.

^[2] Short-circuit durations should be controlled to prevent exceeding the device absolute power dissipation ratings, and not more than one output should be shorted at a time.

Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V \pm 0.5 V.



6.7. Electrical Characteristics - RECEIVER

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

	PARAMETER	TEST CONDITIONS	MIN	TYP ⁽¹⁾	MAX	UNIT	
V _{OH}	High-level output voltage	$I_{OH} = -1 \text{ mA}$	V _{cc} - 0.6	V _{cc} - 0.1		٧	
V _{OL}	Low-level output voltage	I _{OL} = 1.6 mA			0.4	٧	
V _{IT+}	Positive-going input threshold voltage	$V_{CC} = 3.3 \text{ V}$		1.5	2.4	V	
V _{IT+}	Positive-going input timeshold voltage	V _{CC} = 5 V		1.8	2.4	v	
V _{IT} -	Negative going input threshold voltage	$V_{CC} = 3.3 \text{ V}$	0.6	1.2		V	
VIT -	Negative-going input threshold voltage	V _{CC} = 5 V	0.8	1.5		V	
V_{hys}	Input hysteresis ($V_{IT+} - V_{IT}$)				0.3	V	
ri	Input resistance	V _I = ±3 V to ±25 V	3	5	7	kΩ	

^[1] All typical values are at VCC = 3.3 V or VCC = 5 V, and TA = 25°C .

6.8. Switching Characteristics

over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (See Figure 9-1.).

	PARAMETER	TEST CONDITIONS			TYP ⁽²⁾	MAX	UNIT
	Maximum data rate	RL = $3 k\Omega$, One DOUT switching,	CL = 1000 pF, see Figure 7-1	150	250		kbit/s
tsk(p)	Driver pulse skew(3)	RL = 3 kΩ to 7 kΩ, see Figure 7-2	CL = 150 pF to 2500 pF,		300		ns
	Driver slew rate, transition region	RI = 3 kO to 7 kO. VCC = 3.3	CL = 150 pF to 1000 pF	6		30	
SR(tr)	(see Figure 7-1)	v v	CL = 150 pF to 2500 pF	4		30	V/µs
tPLH	Receiver propagation delay time, low- to high-level output		150 -5		300		ns
tPHL	Receiver propagation delay time, high- to low-level output	CL = 150 pF, see Figure 7-3			300		ns
tsk(p)	Receiver pulse skew ⁽³⁾				300		ns

^[1] All typical values are at Vcc = 3.3 V or Vcc = 5 V, and TA = 25°C.

www.xinluda.com 6 / 16 Rev 2.3

Test conditions are C1–C4 = 0.1 μ F at VCC = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at VCC = 5 V \pm 0.5 V.

^[2] Pulse skew is defined as |tPLH - tPHL| of each channel of the same device.

^[3] Test conditions are C1–C4 = 0.1 μ F at Vcc = 3.3 V \pm 0.3 V; C1 = 0.047 μ F, C2–C4 = 0.33 μ F at Vcc = 5 V \pm 0.5 V.



6.9. Typical Characteristics

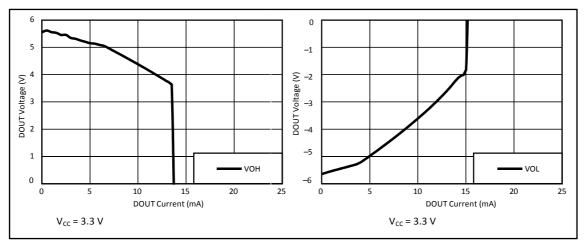


Figure 6-1. DOUT VOH vs Load Current, Both Drivers Loaded

Figure 6-2. DOUT VOL vs Load Current, Both Drivers Loaded

7. Parameter Measurement Information

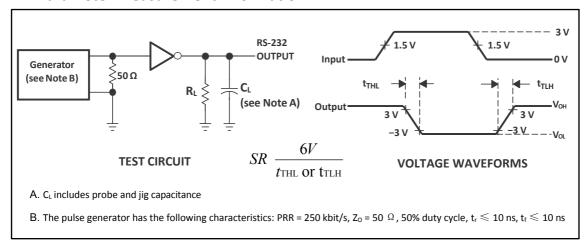


Figure 7-1. Driver Slew Rate

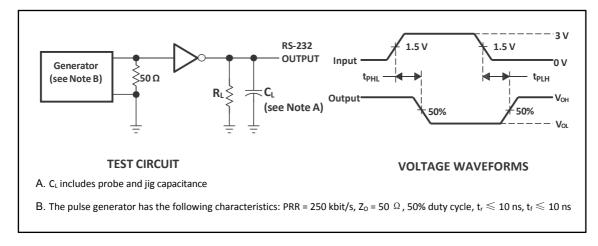


Figure 7-2. Driver Pulse Skew

www.xinluda.com 7/16 Rev 2.3



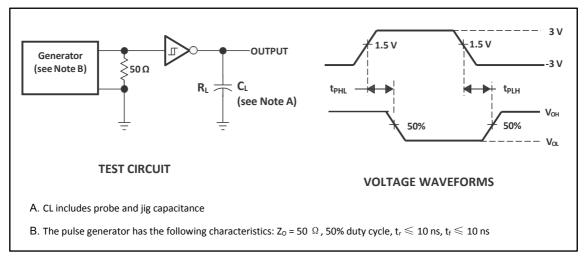


Figure 7-3. Receiver Propagation Delay Times

www.xinluda.com 8 / 16 Rev 2.3



8. Detailed Description

8.1. Overview

The 3232 series devices consists of two line drivers, two-line receivers, and a dual charge-pump circuit with IEC61000-4-2 ESD protection terminal to terminal (serial-port connection terminals, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between an asynchronous communication controller and the serial-port connector. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. The device operates at data signaling rates up to 250 kbit/s and a maximum of 30-V/µs driver output slew rate. Outputs are protected against shorts to ground.

8.2. Feature Description

8.2.1. Power

The power block increases, inverts, and regulates voltage at V+ and V- pins using a charge pump that requires four external capacitors.

8.2.2. RS232 Driver

Two drivers interface standard logic level to RS232 levels. Both DIN inputs must be valid high or low.

8.2.3. RS232 Receiver

Two receivers interface RS232 levels to standard logic levels. An open input will result in a high output on ROUT. Each RIN input includes an internal standard RS232 load.

8.3. Device Functional Modes

Table 8-1 and Talbe 8-2 list the functional modes of the drivers and receivers of 3232.

Table 8-1. Each Driver(1)

INPUT DIN	OUTPUT DOUT
L	Н
Н	L

[1] H = high level, L = low level

Table 8-2. Each Receiver⁽¹⁾

INPUT RIN	OUTPUT ROUT
L	н
Н	L
Open	Н

[1] H = high level, L = low level,

Open = input disconnected or connected driver off

8.3.1. VCC Powered by 3 V to 5.5 V

The device is in normal operation.

8.3.2. VCC Unpowered, VCC = 0 V

When 3232 is unpowered, it can be safely connected to an active remote RS232 device.

www.xinluda.com 9 / 16 Rev 2.3



9. Application and Implementation

9.1. Application Information

For proper operation, add capacitors as shown in Figure 9-1.

9.2. Typical Application

ROUT and DIN connect to UART or general-purpose logic lines. RIN and DOUT lines connect to a RS232 connector or cable.

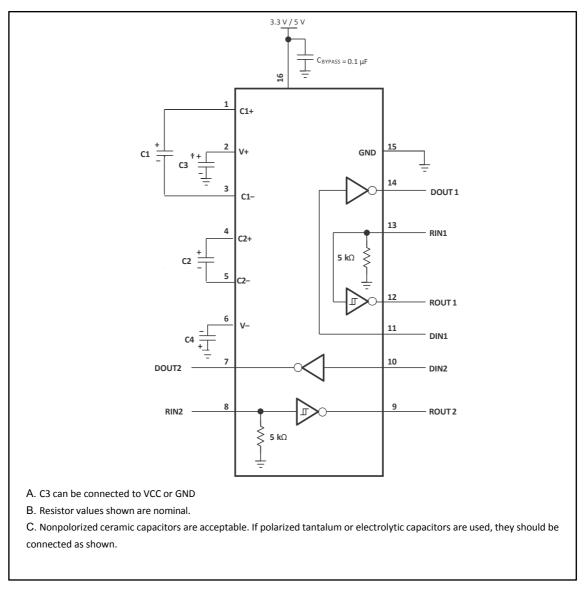


Figure 9-1. Typical Operating Circuit and Capacitor Values

<u>www.xinluda.com</u> 10 / 16 Rev 2.3



9.2.1. Design Requirements

The recommended VCC is 3.3 V or 5 V. 3 V to 5.5 V is also possible The maximum recommended bit rate is 250 kbit/s.

9.2.2. Detailed Design Procedure

All DIN inputs must be connected to valid low or high logic levels. Select capacitor values based on VCC level for best performance.

9.2.3. Application Curve

Figure 9-2 curves are for 3.3-V VCC and 250-kbit/s alternative bit data stream.

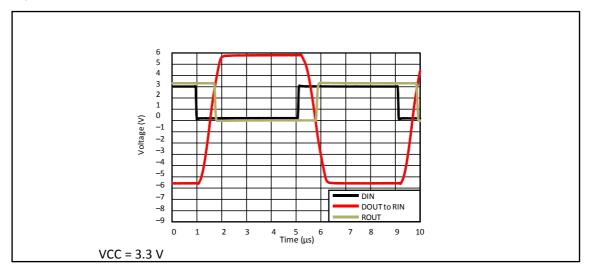


Figure 9-2. 250 kbit/s Driver to Receiver Loopback Timing Waveform

10. Power Supply Recommendations

The supply voltage, VCC, should be between 3 V and 5.5 V. Select the values of the charge-pump capacitors using Table 9-1.

www.xinluda.com 11 / 16 Rev 2.3

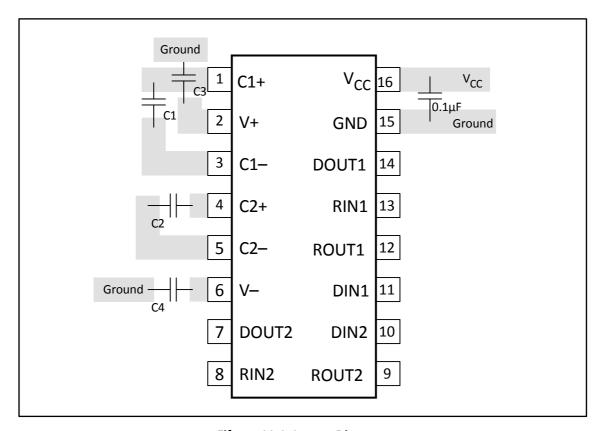


11. Layout

11.1. Layout Guidelines

Keep the external capacitor traces short, specifically on the C1 and C2 nodes that have the fastest rise and fall times.

11.2. Layout Example



Fifgure 11-1. Layout Diagram

www.xinluda.com 12 / 16 Rev 2.3

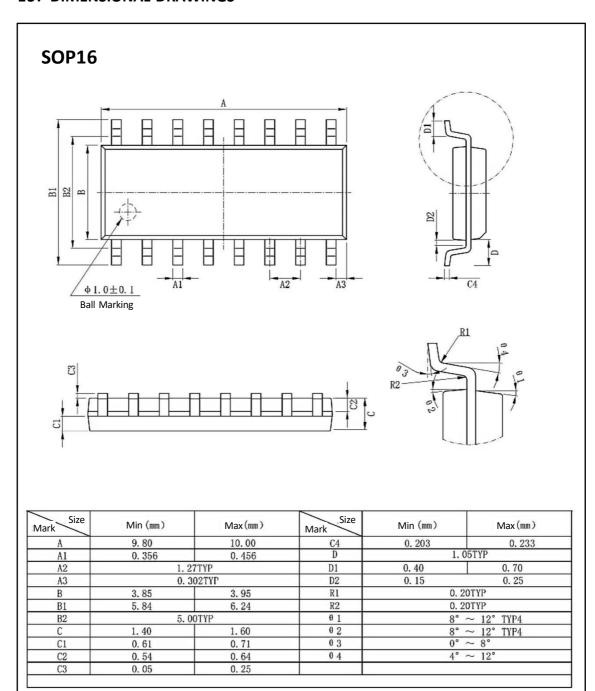


12. ORDERING INFORMATION

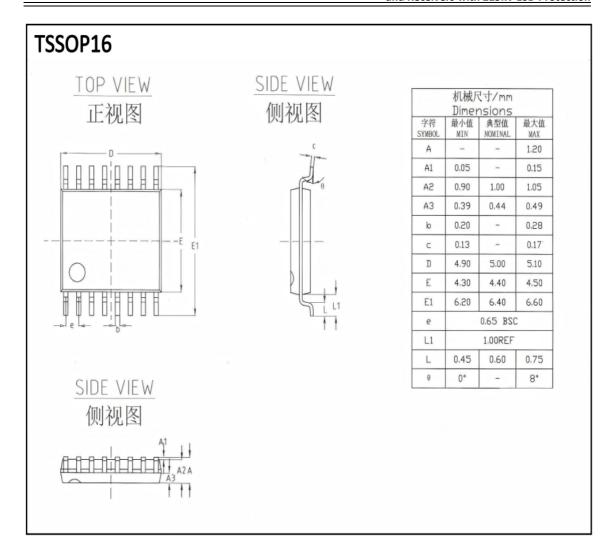
Ordering Information

Part Number	Device Marking	Package Type	Body size (mm)	Temperature (°C)	MSL	Transport Media	Package Quantity
XL3232	XL3232	SOP16	10.00 * 3.95	- 40 to 85	MSL3	T&R	2500
XL3232-TS	XL3232-TS	TSSOP16	5.00 * 4.40	- 40 to 85	MSL3	T&R	2500
XL3232K	XL3232K	SOP16(W)	10.45 * 7.5	- 40 to 85	MSL3	T&R	1000
XD3232	XD3232	DIP16	19.05 * 6.35	- 40 to 85	MSL3	Tube 25	1000

13. DIMENSIONAL DRAWINGS







www.xinluda.com 14 / 16 Rev 2.3



